

Preliminary

TOSHIBA Photocoupler GaAIAs IRED & Photo-IC

# **TLP716**

Digital Isolation for A/D,D/A Conversion. High Speed Line Receiver. Microprocessor System Interfaces. Plasma display panel.

The TOSHIBA TLP716 consists of a GaAlAs light emitting diode and a high speed photodetector. This unit is 6-lead SDIP. TLP716 is 50% smaller than 8PIN DIP and has suited the safety standard reinforced insulation class. So mounting area in safety standard required equipment can be reduced.

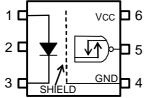
- Inverter Logic (totempole output)
- Package Type : SDIP6
- Guaranteed Performance Over Temperature : -40~100°C
- Power Supply Voltage : 4.5~5.5V
- Input Thresholds Current : IFHL=6.5mA(max.)
- Propagation delay Time (tpHL/ tpLH) : 75ns(max.)
- Switching speed : 20MBd(typ.) (NRZ)
- Common mode transient immunity : 10kV/us
- Isolation Voltage : 5000Vrms
- Construction Mechanical Rating

	7.62 mm pich standard type	10.16 mm pich TLPXXXF type
Creepage Distance	7.0 mm (min)	8.0 mm (min)
Clearance	7.0 mm (min)	8.0 mm (min)
Insulation Thickness	0.4 mm (min)	0.4 mm (min)

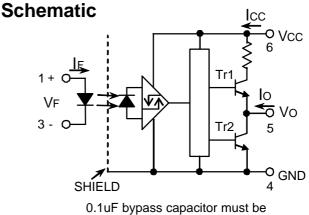
# **Truth Table**

Input	LED	Tr1	Tr2	Output
н	ON	OFF	ON	L
L	OFF	ON	OFF	Н

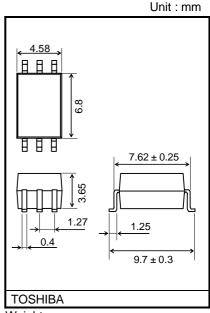
### Pin Configuration (top view)



1:Anode 3:Cathode 4:GND 5:Vo 6:Vcc



connected between pin 6 and 4



Weight: ---g

# Maximum Ratings (Ta=25°C )

	CHARACTERISTIC	SYMBOL	RATING	UNIT
	Forward Current	IF	20	mA
LED	Peak Transient Forward Current (Note1)	IFPT		А
	Reverse Voltage	VR	5	V
к	Output Current	ю	10	mA
DETECTOR	Output Voltage	VO	6	V
Ĕ	Supply Voltage	VCC	6	V
ä	Output power dissipation	PO	40	mW
Oper	ating Temperature Range	Topr	-40~100	°C
Stora	ge Temperature Range	Tstg	-55~125	°C
Lead	Solder Temperature(10s)	Tsol	260	°C
	tion Voltage C,1min.,R.H.=60%,Ta=25°C) (Note2)	BVs	5000	Vrms

Note1 : Pulse width PW=10us,500pps.

Note2 : Device Considered a two terminal device : pins 1,2 and 3 shorted together and pins 4,5 and 6 shorted together.

# **Recommended Operating Conditions**

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Input Current, ON	IF(ON)	8	12	18	mA
Input Voltage, OFF	VF(OFF)	0		0.8	V
Supply Voltage	VCC	4.5	5	5.5	V
Operating Temperature	Topr	-40		100	°C

# The correlation between input current and switching speed and drive circuit (reference information).

Input Current (IF)	TEST CIRCUIT	Typical Switching Speed
12mA	1 (Page 4)	18 – 20 MBd
8mA	1 (Page 4)	16 – 18 MBd
8mA	2 (Page 4,With Speed up capacitor)	20 – 22 MBd

Unless otherwise specified, Ta=-40 to 100°C, VCC=4.5~5.5V)								
CHARACTERISTIC	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT		
Input Forward Voltage	VF	IF=10mA ,Ta=25°C	_	1.65	1.8	V		
Temperature Coefficient of Forward Voltage	?VF/?Ta	IF=10mA	_	-2.0	_	mV/°C		
Input Reverse Current	IR	VR=5V,Ta=25°C	—	_	10	μA		
Input Capacitance	Ст	V=0,f=1MHz,Ta=25°C	—		_	pF		
Logic Low Output Voltage	VOL	IOL=1.6mA, IF=12mA,VCC=5V	—	—	0.4	V		
Logic High Output Voltage	Vон	IOH=-0.02mA , VF=1.05V,VCC=5V	4.0	—	—	V		
Logic Low Supply Current	ICCL	IF=12mA	-	—	5.0	mA		
Logic High Supply Current	ICCH	VF=0V (Note4)	_		5.0	mA		
Input Current Logic Low Output	IFHL	IO=1.6mA,VO<0.4V	_	_	6.5	mA		
Input Voltage Logic High Output	VFLH	IO=-0.02mA,VO>4.0V	0.8	_	_	V		

# **Electrical Characteristics**

# (Unless otherwise specified, Ta=-40 to 100°C,Vcc=4.5~5.5V)

\*All typical values are at Ta=25°C,VCC=5V,IF=(ON)=5mA unless otherwise specified

Note4 : The Photodetector needs VCC of 4.5V or more for the stability operation.

In the VCC domain not more than this, since ICCH may increase in part, please use it after checking operation at the time of power supply current, power supply ON, and OFF.

# Isolation Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Capacitance input to output	CS	V = 0,f = 1MHz (Note 2	) ?	0.8	?	pF
Isolation resistance	R <sub>S</sub>	R.H. = 60%,V <sub>S</sub> = 500V (Note 2	) 1×10 <sup>12</sup>	10 <sup>14</sup>	?	0
		AC,1 minute	5000	?	?	V <sub>rms</sub>
Isolation voltage	BVS	AC,1 second,in oil	?	10000	?	Vdc
		DC,1 minute,in oil	?	10000	?	vuc

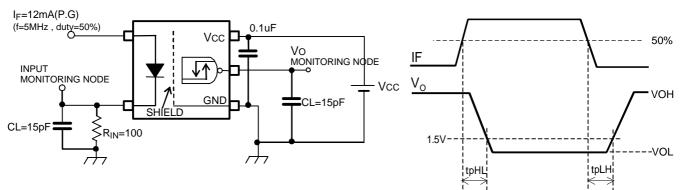
#### Switching Characteristics (Unless otherwise specified, Ta= Ta=-40 to 100°C,Vcc=4.5~5.5V)

		00 0,100=4		•/				
CHARACTERISTIC	SYMB OL	TEST -CIRCUI T	CONE	DITION	MIN.	TYP.	MAX.	UNIT
propagation Delay Time to Logic High output	tpLH	1	IF=0? 12m A	RIN=1000 CL=15pF	_		75	ns
propagation Delay Time to Logic Low output	tpHL	1	IF=12 0mA	(Note 4)	—		75	ns
propagation Delay Time to Logic High output	tpLH		V <sub>IN</sub> =5 0V (IF=8 0mA)	R <sub>IN</sub> =430 C <sub>IN=</sub> 33pF	_		65	ns
propagation Delay Time to Logic Low output	tpHL	2	V <sub>IN</sub> =0 5V (IF=0 8mA)	CL=15pF (Note 4)	_		65	ns
Switching Time Dispersion between ON and OFF	tpHL- tpLH		R <sub>IN</sub> =100 , CL	_=15pF (Note 4)	_	_	45	ns
Output Rise Time	tr	1	IF=0 12mA	R <sub>IN</sub> =100 CL=15pF	_		_	ns
Output Fall Time	ťf		IF=12 0mA	(Note 4)	—		—	ns
Common Mode transient Immunity at High Level Output	СМН	2	VCM=1000Vp-p Vo(Min)=4V,Ta=		-10000		_	V/us
Common Mode transient Immunity at Low Level Output	CML	3	VCM=1000Vp-p Vo(Max)=0.4V,7		10000	_	_	V/us

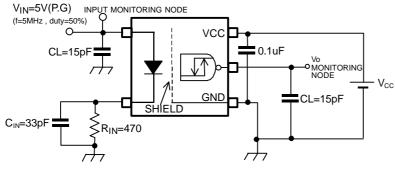
\*All typical values are at Ta=25°C

Note 4 : Capacity of a probe and a wire.

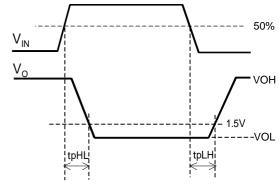
### TEST CIRCUIT 1 : tpLH , tpHL



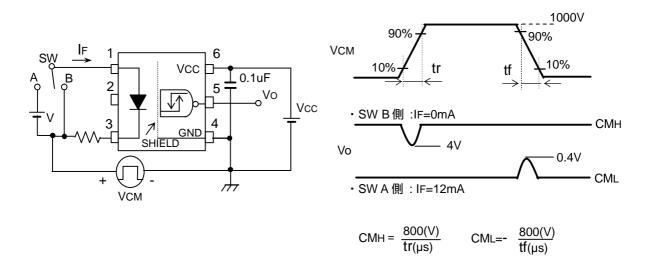
#### TEST CIRCUIT 2 : tpLH , tpHL



The PROBE and JIG capacitances are included in CL. (P.G) : Pulse Generatior



TEST CIRCUIT 3 : CMH , CML



 $CM_L$  ( $CM_H$ ) is the maximum rate of rise (fall) of the common mode voltage that can be sustained with the output voltage in the low (high) state.

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